

REV.	DESCRIPTION	APPD	DATE
B/1	滑块底部加避位槽	杨凯	0112'10
B/2	主体金手指侧面增加避位	杨凯	0324'10

NOTES:

1.MATERIAL:

HOUSING: HIGH TEMPERATURE THERMOPLASTIC
UL94V_0,COLOR:BLACK.

CONTACT: COPPER ALLOYS.

COVER: COPPER ALLOYS OR STEEL.

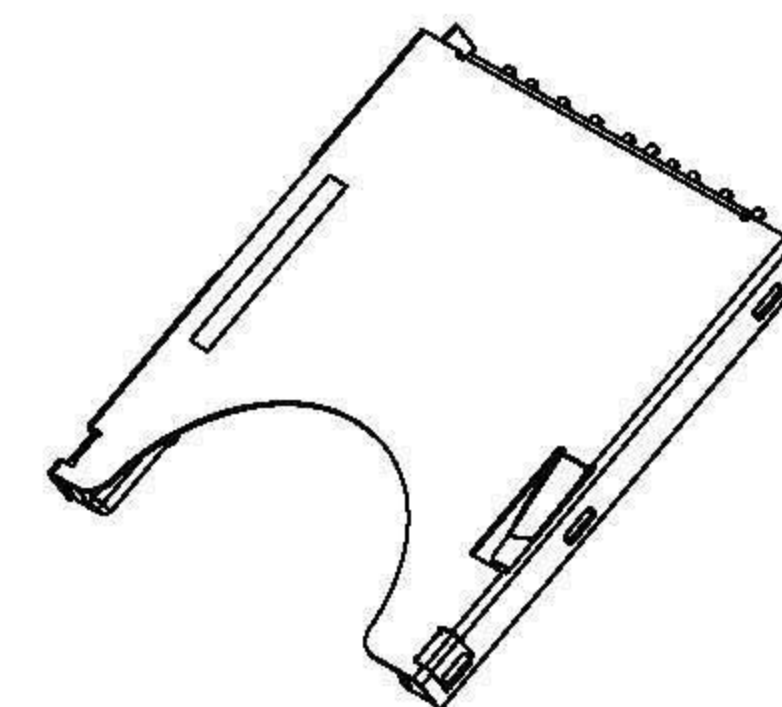
2.PLATING:

UNDERPLATE: NICKEL.

CONTACT AREA: GOLD OVER NICKEL.

SOLDER AREA: TIN OVER NICKEL.

3.MULTIMEDIA CARD COMPATIBLE



PART NO: SD-0201P		MATERIAL:		深圳市连欣科技有限公司	
LOT NO:		FINSH:			
UNIT: MM	SIZE: A4	COLOR:			
TOLERANCES: X.X=±0.35 X.XX=±0.25 X.XXX=±0.15 GENERAL ANGLE: X.X=±5.0° X.XX=±3.0°		DR: 杨凯 08/26/09		TITLE: SD PUSH卡座	
		CHK:		DWG NO: XFSD-0526-0823	
		APP:		SCALE: 1:1	
				REV: B/3	
				SHEET: 1 OF 3	

